

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6350240

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| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT   |
| <b>NATURE OF CONVEYANCE:</b>  | SECURITY INTEREST  |
| <b>SEQUENCE:</b>  | 2  |
| <b>CONVEYING PARTY DATA</b>   |  |
| <b>Name</b>   | <b>Execution Date</b>  |
| ARRAY TECHNOLOGIES, INC.  | 10/14/2020   |
| <b>RECEIVING PARTY DATA</b>   |  |
| <b>Name:</b>  | GOLDMAN SACHS BANK USA, AS ADMINISTRATIVE AGENT AND COLLATERAL AGENT |
| <b>Street Address:</b>  | 200 WEST STREET  |
| <b>City:</b>  | NEW YORK   |
| <b>State/Country:</b>   | NEW YORK   |
| <b>Postal Code:</b>   | 10282-2198   |
| <b>PROPERTY NUMBERS Total: 14</b>   |  |
| <b>Property Type</b>  | <b>Number</b>  |
| Patent Number:  | 9281778  |
| Patent Number:  | 10069455   |
| Patent Number:  | 9581678  |
| Patent Number:  | 10042030   |
| Application Number:   | 16055663   |
| Patent Number:  | 9631840  |
| Patent Number:  | 8459249  |
| Patent Number:  | 10536109   |
| Application Number:   | 16741597   |
| Patent Number:  | 10771007   |
| Application Number:   | 62948132   |
| Application Number:   | 29717081   |
| Application Number:   | 17061341   |
| Application Number:   | 17061350   |
| <b>CORRESPONDENCE DATA</b>  |  |
| <b>Fax Number:</b>  |  |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> |  |

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|                                |         |
|--------------------------------|---------|
| <b>ATTORNEY DOCKET NUMBER:</b> | 1277015 |
|--------------------------------|---------|

|                           |           |
|---------------------------|-----------|
| <b>NAME OF SUBMITTER:</b> | DAPHNE XU |
|---------------------------|-----------|

|                   |             |
|-------------------|-------------|
| <b>SIGNATURE:</b> | /Daphne Xu/ |
|-------------------|-------------|

|                     |            |
|---------------------|------------|
| <b>DATE SIGNED:</b> | 10/14/2020 |
|---------------------|------------|

**Total Attachments: 7**

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## PATENT SECURITY AGREEMENT

WHEREAS, Array Technologies, Inc., a New Mexico corporation (herein referred to as the “**Grantor**”) owns the Patent Collateral (as defined below);

WHEREAS, the Grantor, the Lenders party thereto, and Goldman Sachs Bank USA, as Administrative Agent and Collateral Agent, are parties to that certain Credit Agreement, dated as of October 14, 2020 (as amended from time to time, the “**Credit Agreement**”); and

WHEREAS, pursuant to that certain Security Agreement, dated as of October 14, 2020, (as amended and/or supplemented from time to time, the “**Security Agreement**”) among the Grantor, the Guarantors party thereto and Goldman Sachs Bank USA, as Collateral Agent for the Secured Parties referred to therein (in such capacity, together with its successors in such capacity, the “**Grantee**”), the Grantor has secured certain of its obligations (its “**Secured Obligations**”) by granting to the Grantee for the benefit of such Secured Parties a continuing security interest (the “**Transaction Liens**”) in certain personal property of the Grantor, including all right, title and interest of the Grantor in, to and under the Patent Collateral (as defined below);

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Grantor grants to the Grantee, to secure its Secured Obligations, a continuing security interest in all of the Grantor’s right, title and interest in, to and under the following to the extent it constitutes Collateral (including giving effect to the proviso in Section 2(a) thereof) (all of the following items, to the extent constituting Collateral being herein collectively referred to as the “**Patent Collateral**”), whether now owned or existing or hereafter acquired or arising:

- (i) each Patent owned by the Grantor and identified in Schedule 1 hereto; and
- (ii) all Proceeds of the foregoing.

This Patent Security Agreement shall not constitute a grant of a security interest in any property to the extent that and for as long as such property is excluded as Collateral by the terms of the Security Agreement, including in any Excluded Property.

The Grantor irrevocably appoints the Grantee its true and lawful attorney, with full power of substitution, in the name of the Grantor, any Secured Party or otherwise, for the sole use and benefit of the Secured Parties, but at the Grantor’s expense, to the extent permitted by Law to exercise, at any time and from time to time while any Event of Default shall have occurred and be continuing and/or an Enforcement Notice is in effect all or any of the powers provided for in Section 15 of the Security Agreement with respect to all or any of the Patent Collateral.

The foregoing security interest has been granted under the Security Agreement. The Grantor acknowledges and affirms that the rights and remedies of the Grantee with respect to the security interest in the Patent Collateral granted hereby are more fully set forth in the Security Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein. In the event of a conflict between the Security Agreement and this Patent Security Agreement, the terms of the Security Agreement shall control.

Upon termination of the Transaction Liens in the Patent Collateral pursuant to the Security Agreement, the security interests granted hereby shall automatically terminate and be released, and the

Grantee will, at the expense of the Grantor, execute and deliver to the Grantor such documents, and take such other actions, as the Grantor shall reasonably request to evidence the termination of the security interests granted hereby.

Capitalized terms used but not defined herein but defined in the Security Agreement are used herein with the respective meanings provided for therein.

[Signature pages follow]

IN WITNESS WHEREOF, the Grantor has caused this Patent Security Agreement to be duly executed by its officer thereunto duly authorized as of the date first written above.

**ARRAY TECHNOLOGIES, INC.,**  
a New Mexico corporation,  
as Grantor

By:   
Name: Nipun Patel  
Title: Chief Financial Officer

[Signature Page to Patent Security Agreement]

**PATENT**  
**REEL: 054055 FRAME: 0611**

Acknowledged:

GOLDMAN SACHS BANK USA,  
as Collateral Agent

By: 

Name: Robert Ehudin

Title: Authorized Signatory

**Schedule 1  
to Patent  
Security Agreement**

**ARRAY TECHNOLOGIES, INC.**

**PATENTS**

| <b><u>Title</u></b>  | <b><u>Jurisdiction</u></b> | <b><u>Application<br/>No./<br/>Filing Date</u></b> | <b><u>Publication<br/>No.</u></b> | <b><u>Patent No./<br/>Issue Date</u></b> | <b><u>Status</u></b> | <b><u>Current Owner of<br/>Record</u></b> |
|--|----------------------------|--|-----------------------------------|--|----------------------|---|
| Mounting bracket assemblies and methods  | U.S.                       | 14/044,704<br>10/2/2013                            | 20150092383                       | 9281778<br>3/8/2016                      | Issued               | Array Technologies, Inc.                  |
| Mounting bracket assemblies and methods  | U.S.                       | 15/063,098<br>3/7/2016                             | 20160190976                       | 10069455<br>9/4/2018                     | Issued               | Array Technologies, Inc.                  |
| Torque limiter devices, systems and methods and solar trackers incorporating torque limiters | U.S.                       | 14/624,930<br>2/18/2015                            | 20150234031                       | 9581678<br>2/28/2017                     | Issued               | Array Technologies, Inc.                  |
| Torque limiter devices, systems and methods and solar trackers incorporating torque limiters | U.S.                       | 15/437,488<br>2/21/2017                            | 20170160372                       | 10042030<br>8/7/2018                     | Issued               | Array Technologies, Inc.                  |

| <u>Title</u>   | <u>Jurisdiction</u> | <u>Application No./ Filing Date</u> | <u>Publication No.</u> | <u>Patent No./ Issue Date</u> | <u>Status</u> | <u>Current Owner of Record</u> |
|--|---------------------|-------------------------------------|------------------------|-------------------------------|---------------|--------------------------------|
| Torque limiter devices, systems and methods and solar trackers incorporating torque limiters         | U.S.                | 16/055,663<br>8/6/2018              | 20180348331            | —                             | Allowed       | Array Technologies, Inc.       |
| Single axis solar tracking system  | U.S.                | 13/895,117<br>5/15/2013             | 20140338659            | 9631840<br>4/25/2017          | Issued        | Array Technologies, Inc.       |
| Single axis solar tracking system  | U.S.                | 12/137,764<br>6/12/2008             | 20080308091            | 8459249<br>6/11/2013          | Issued        | Array Technologies, Inc.       |
| Clip-on mounting rails, mounting brackets, and methods of mounting solar modules                     | U.S.                | 15/618,408<br>6/9/2017              | 20170359017            | 10536109<br>1/14/2020         | Issued        | Array Technologies, Inc.       |
| Clip-on mounting rails, mounting brackets, and methods of mounting solar modules                     | U.S.                | 16/741,597<br>1/13/2020             | 20200162016            | —                             | Pending       | Array Technologies, Inc.       |
| Spring counter-balance assemblies and solar trackers incorporating spring counter-balance assemblies | U.S.                | 15/909,142<br>3/1/2018              | 20180254740            | 10771007<br>9/8/2020          | Issued        | Array Technologies, Inc.       |



| <u>Title</u>            | <u>Jurisdiction</u> | <u>Application No./ Filing Date</u> | <u>Publication No.</u> | <u>Patent No./ Issue Date</u> | <u>Status</u> | <u>Current Owner of Record</u> |
|-------------------------|---------------------|-------------------------------------|------------------------|-------------------------------|---------------|--------------------------------|
| Unpublished application | U.S.                | 62/948,132<br>12/13/2019            | —                      | —                             | Pending       | Array Technologies, Inc.       |
| Unpublished application | U.S.                | 29/717,081<br>12/13/2019            | —                      | —                             | Pending       | Array Technologies, Inc.       |
| Unpublished application | U.S.                | 17/061,341<br>10/1/2020             | —                      | —                             | Pending       | Array Technologies, Inc.       |
| Unpublished application | U.S.                | 17/061,350<br>10/1/2020             | —                      | —                             | Pending       | Array Technologies, Inc.       |